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AUG 2 5 2005

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: In-De Ou et al.

Confirmation No: 4280

Appl. No. Filed

10/627,609

Title

: July 28, 2003 : CIRCUIT SUBSTRATE AND FABRICATION METHOD

**THEREOF** 

TC/A.U.

: 2818

Examiner

: Phuc T. Dang

Docket No.:

: OUIN3001/REF

Customer No:

: 23364

## **AMENDMENT**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action of May 25, 2005, in connection with the above-identified application. This response is timely filed.

Please amend the application as follows:

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.